CMOS LDO Regulator Series for Portable Equipments

Versatile Package FULL CMOS LDO Regulator

BUxxUA3WNVX series

●General Description

BUxxUA3WNVX series is high-performance FULL CMOS regulator with 300-mA output, which is mounted on versatile package SSON004X1010 (1.00mm × 1.00 mm × 0.60mm). It has excellent noise characteristics and load responsiveness characteristics despite its low circuit current consumption of 50μA. It is most appropriate for various applications such as power supplies for logic IC, RF, and camera modules.

●Features

- High accuracy detection
- low current consumption
- Compatible with small ceramic capacitor (Cin=Co=1.0uF)
- With built-in output discharge circuit
- High ripple rejection
- ON/OFF control of output voltage
- With built-in over current protection circuit and thermal shutdown circuit
- Low dropout voltage

●Key Specifications

- Output voltage: 1.0V to 3.7V
- Accuracy output voltage: ±1.0% (±25mV)
- Low current consumption: 50μA
- Operating temperature range: -40°C to +85°C

●Applications

Battery-powered portable equipment, etc.

●Package

SSON004X1010 : 1.00mm x 1.00mm x 0.60mm



●Typical Application Circuit

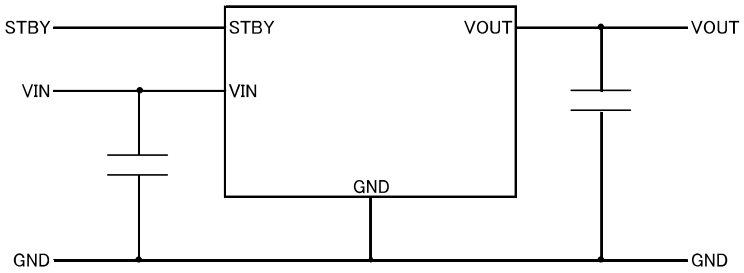
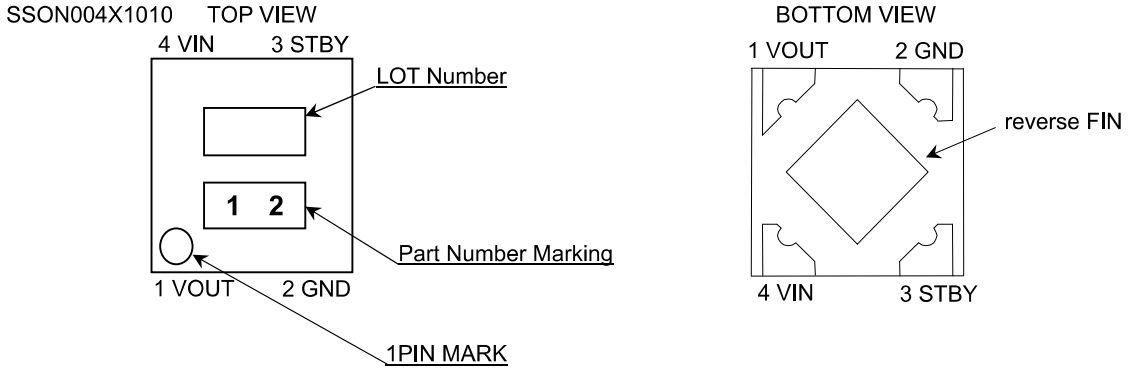


Figure 1. Application Circuit

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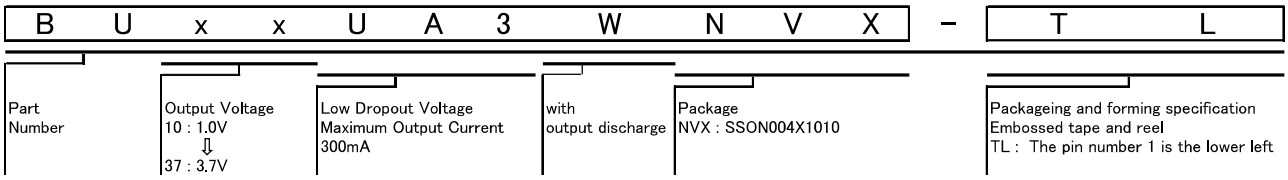
●Connection Diagram



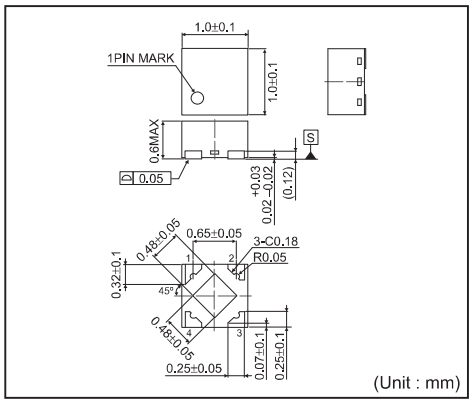
●Pin Descriptions

SSON004X1010		
PIN No.	Symbol	Function
1	VOUT	Output Voltage
2	GND	Grouding
3	STBY	ON/OFF control of output voltage (High: ON, Low: OFF)
4	VIN	Power Supply Voltage
reverse	FIN	Substrate (Connect to GND)

● Ordering Information

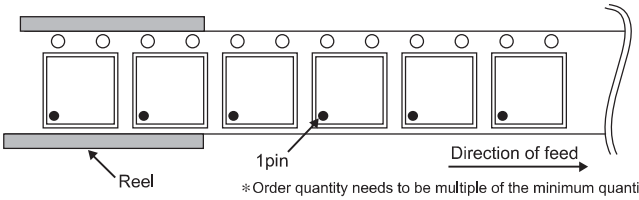


SSON004X1010



<Tape and Reel information>

Tape	Embossed carrier tape
Quantity	5000pcs
Direction of feed	TL (The direction is the 1pin of product is at the lower left when you hold reel on the left hand and you pull out the tape on the left hand)



＊Order quantity needs to be multiple of the minimum quantity.

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●**Lineup**

Marking	e	ml	nl	Ul	Yl	al	ql	Bi	f	g	bl
Output Voltage	1.0V	1.05V	1.1V	1.15V	1.2V	1.25V	1.3V	1.35V	1.5V	1.8V	1.85V
Part Number	BU10	BU1A	BU11	BU1B	BU12	BU1C	BU13	BU1D	BU15	BU18	BU1J

dl	el	fl	gl	rl	hl	h	m	ul	yl	n
1.9V	2.0V	2.05V	2.1V	2.2V	2.3V	2.5V	2.6V	2.7V	2.75V	2.8V
BU19	BU20	BU2A	BU21	BU22	BU23	BU25	BU26	BU27	BU2H	BU28

z	u	0i	k	1i	2i	y	3i	9
2.85V	2.9V	2.95V	3.0V	3.1V	3.2V	3.3V	3.4V	3.7V
BU2J	BU29	BU2K	BU30	BU31	BU32	BU33	BU34	BU37

●**Absolute Maximum Ratings (Ta=25°C)**

PARAMETER	Symbol	Limit	Unit
Power Supply Voltage	VMAX	-0.3 ～ +6.0	V
Power Dissipation	Pd	560(*1)	mW
Maximum junction temperature	TjMAX	+125	℃
Operating Temperature Range	Topr	-40 ～ +85	℃
Storage Temperature Range	Tstg	-55 ～ +125	℃

(∗1) Pd deleted at 5.6mW/℃ at temperatures above Ta=25℃, mounted on 70×70×1.6 mm glass-epoxy PCB.

● **RECOMMENDED OPERATING RANGE (not to exceed Pd)**

PARAMETER	Symbol	Limit	Unit
Power Supply Voltage	VIN	1.7～5.5	V
Maximum Output Current	IMAX	300	mA

●**OPERATING CONDITIONS**

PARAMETER	Symbol	MIN.	TYP.	MAX.	Unit	CONDITION
Input Capacitor	Cin	0.47(*2)	1.0	-	μF	Ceramic capacitor recommended
Output Capacitor	Co	0.47(*2)	1.0	-	μF	

(*2) Make sure that the output capacitor value is not kept lower than this specified level across a variety of temperature, DC bias, characteristic.

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●**Electrical Characteristics**

(Ta=25℃, VIN=VOUT+1.0V (*3), STBY=VIN, Cin=1.0μF, Co=1.0μF, unless otherwise noted.)

PARAMETER		Symbol	Limit			Unit	Conditions
			MIN.	TYP.	MAX.		
Overall Device							
Output Voltage		VOUT	VOUT×0.99	VOUT	VOUT×1.01	V	IOUT=10μA, VOUT≧2.5V
			VOUT-25mV		VOUT+25mV		IOUT=10μA, VOUT＜2.5V
Operating Current		IIN	-	50	90	μA	IOUT=0mA
Operating Current (STBY)		ISTBY	-	-	1.0	μA	STBY=0V
Ripple Rejection Ratio		RR	45	70	-	dB	VRR=-20dBv,fRR=1kHz,IOUT=150mA, VIN=3.6V
Dropout Voltage		VSAT	-	470	700	mV	1.0V≦VOUT＜1.2V(IOUT=300mA)
			-	350	500	mV	1.2V≦VOUT＜1.5V(IOUT=300mA)
			-	280	380	mV	1.5V≦VOUT＜1.7V(IOUT=300mA)
			-	250	320	mV	1.7V≦VOUT＜2.1V(IOUT=300mA)
			-	220	260	mV	2.1V≦VOUT＜2.5V(IOUT=300mA)
			-	200	220	mV	2.5V≦VOUT(IOUT=300mA)
Line Regulation		VDL	-	2	20	mV	VIN=VOUT+1.0V to 5.5V(*4), IOUT=10μA
Load Regulation		VDLO	-	25	45	mV	IOUT=0.01mA to 300mA
Over-current Protection (OCP)							
Limit Current		ILMAX	370	550	-	mA	Vo=VOUT*0.95
Short Current		ISHORT	50	150	300	mA	Vo=0V
Standby Block							
Discharge Resistor		RDSC	20	50	80	Ω	VIN=5.5V, STBY=0V, VOUT=2.6V
STBY Pin Pull-down Current		ISTB	0.1	0.9	8.0	μA	STBY=1.5V
STBY Control Voltage	ON	VSTBH	1.2	-	5.5	V	
	OFF	VSTBL	-0.3	-	0.3	V	

○This product is not designed for protection against radioactive rays.

(*3) VIN=2.5V for VOUT≦1.5V

(*4) VIN=2.5V to 5.5V for VOUT≦1.5V

●**Block Diagrams**

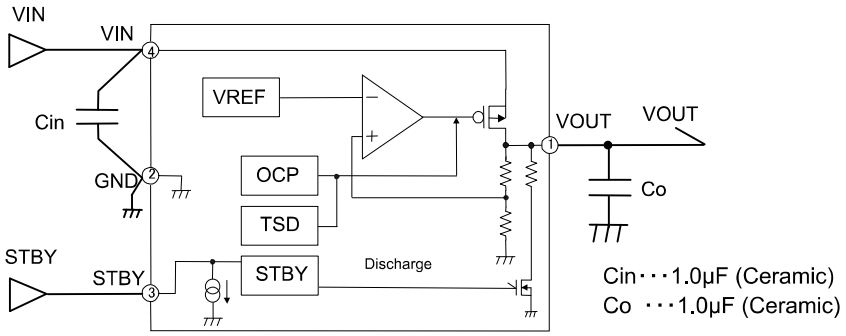


Figure 2. Block Diagrams

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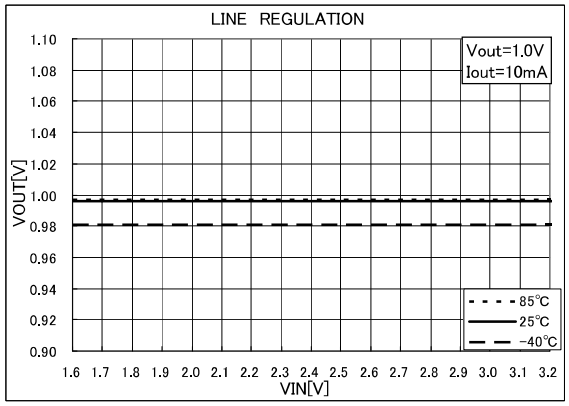


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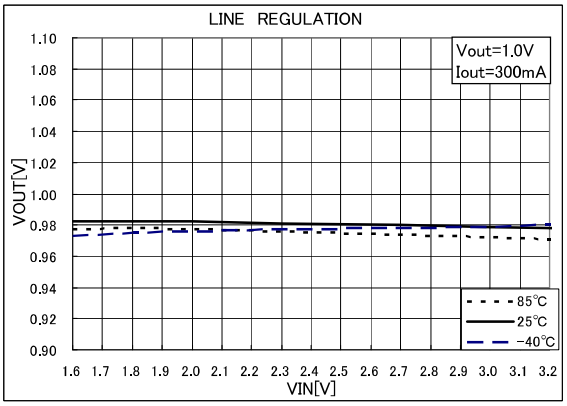


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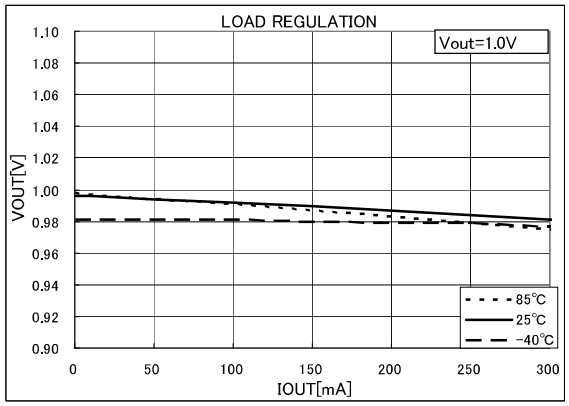


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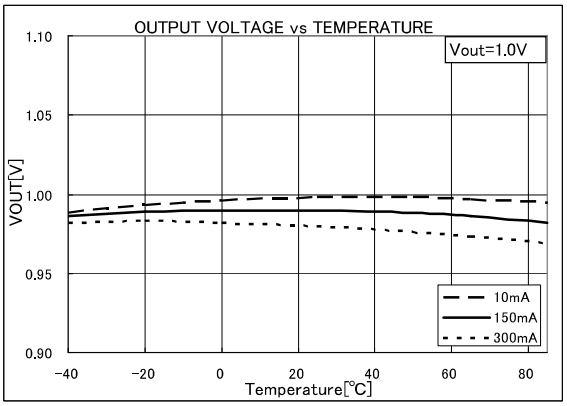


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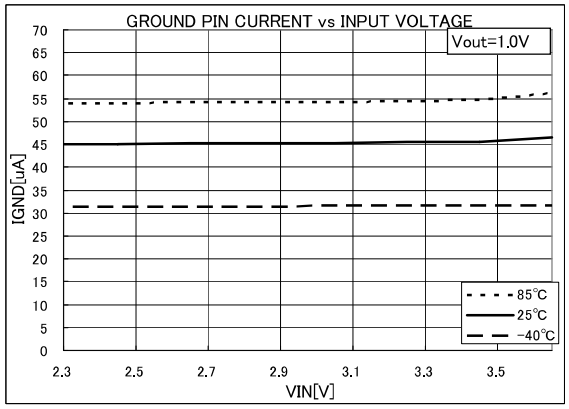


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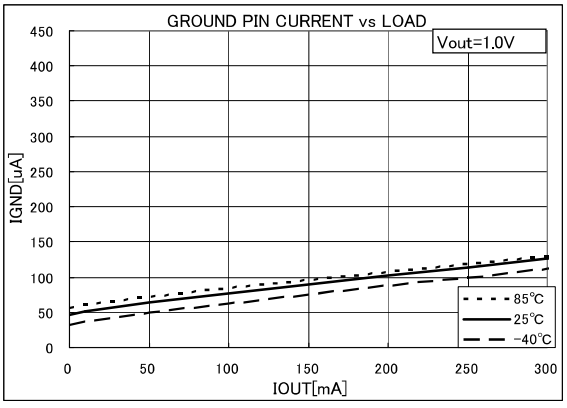


Figure 8.

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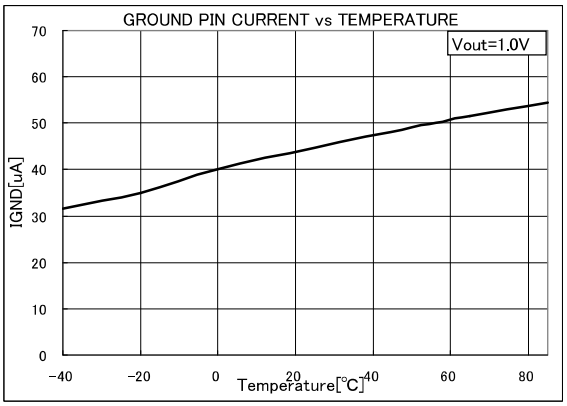


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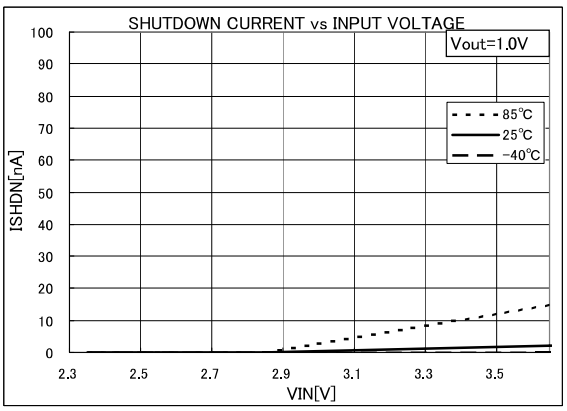


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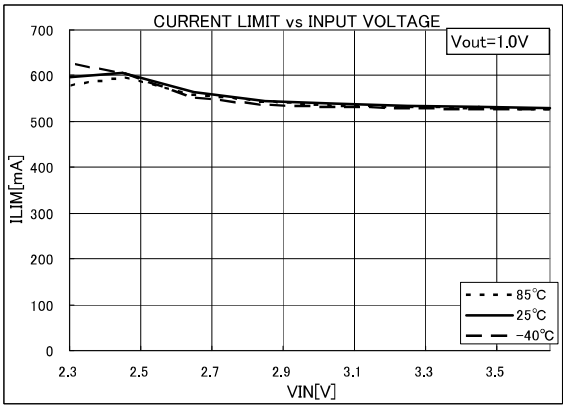


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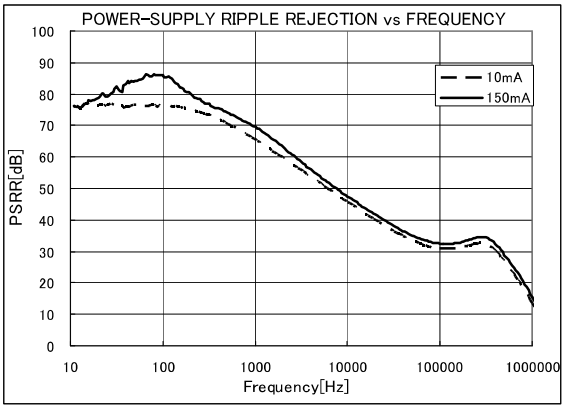


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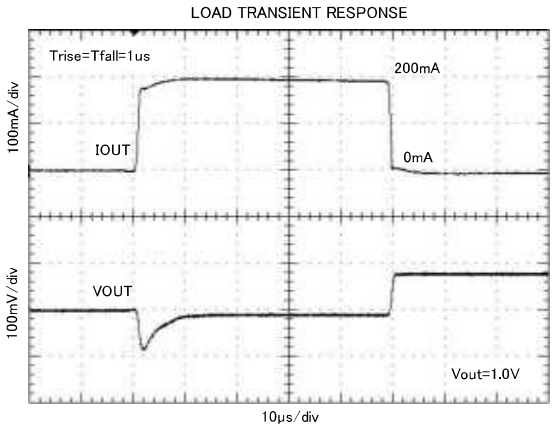


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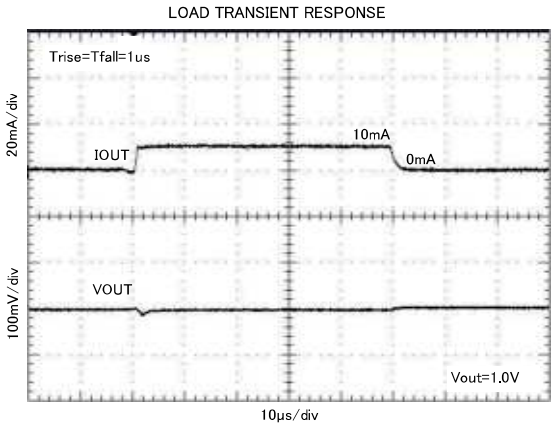


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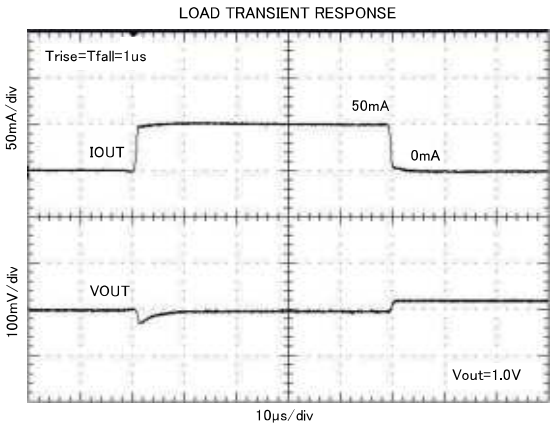


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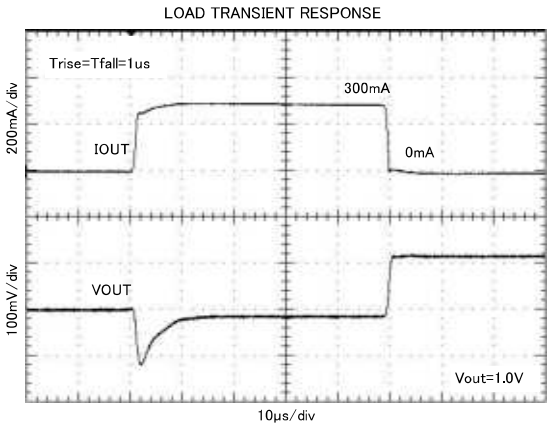


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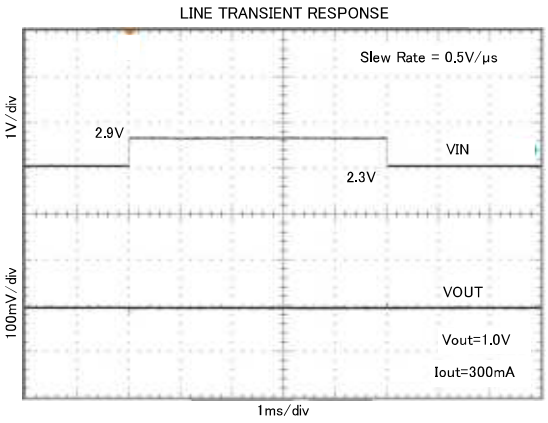


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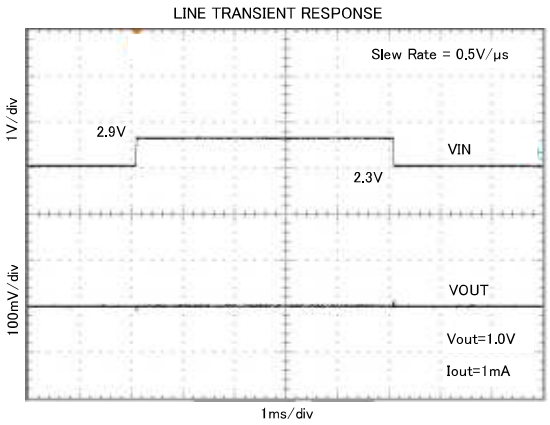


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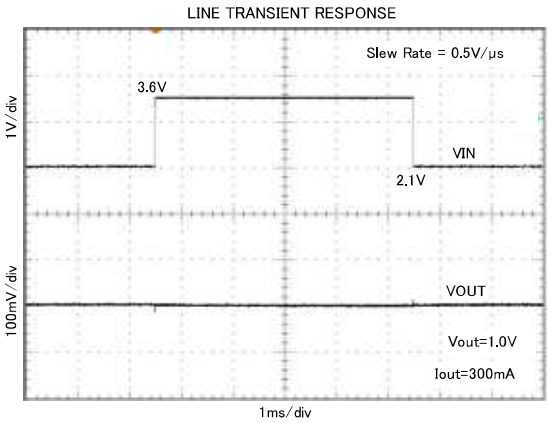


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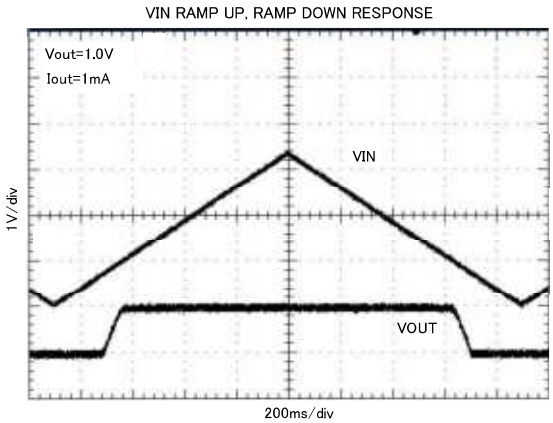


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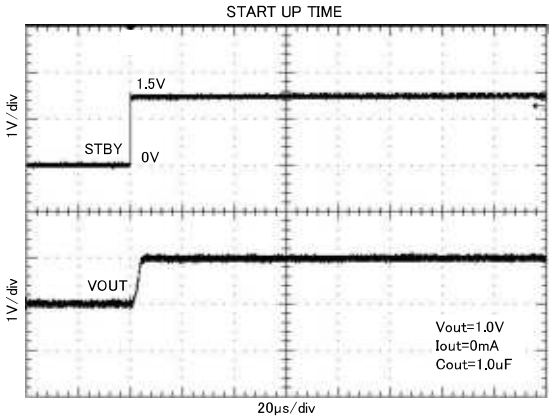


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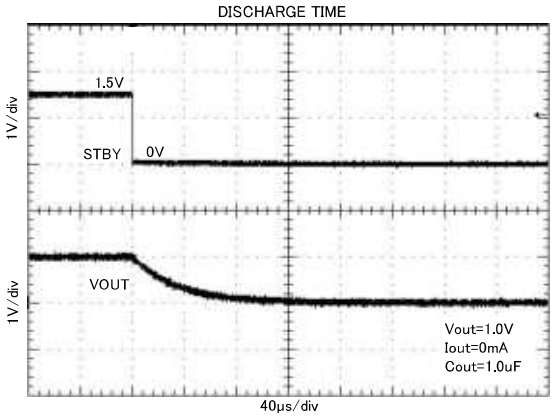


Figure 22.

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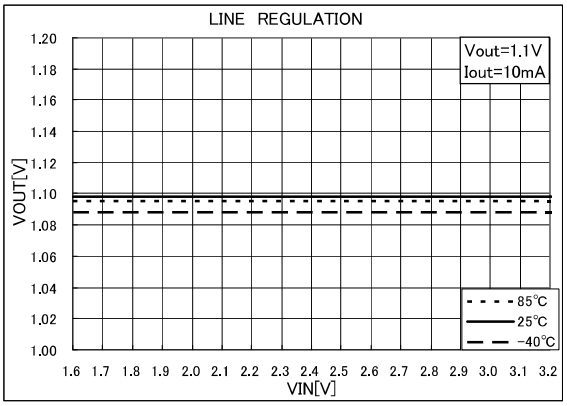


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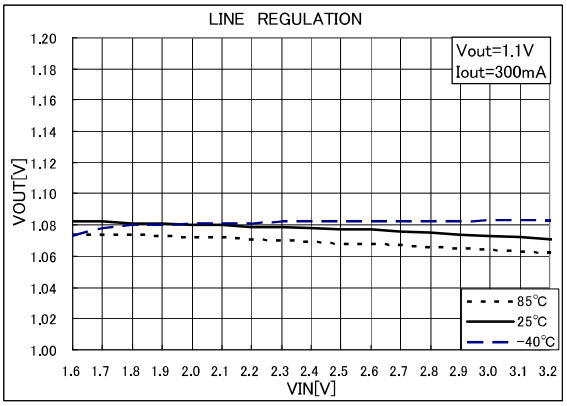


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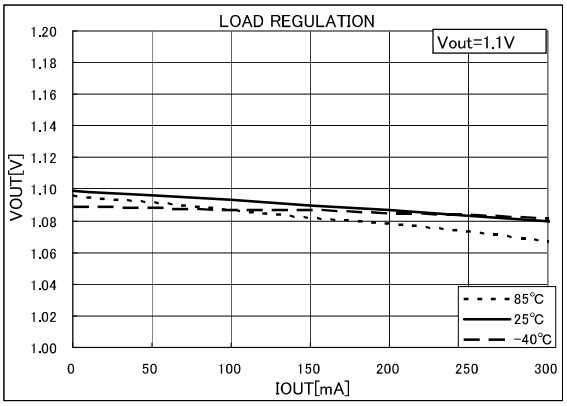


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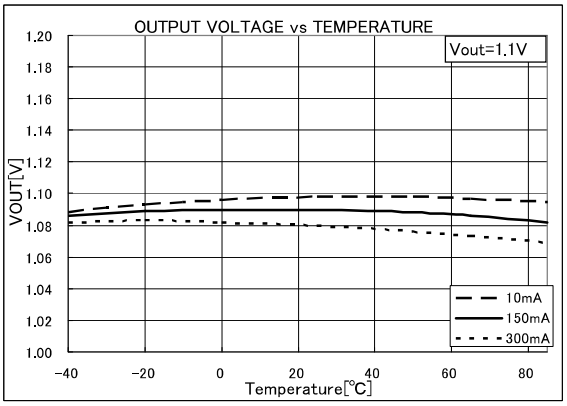


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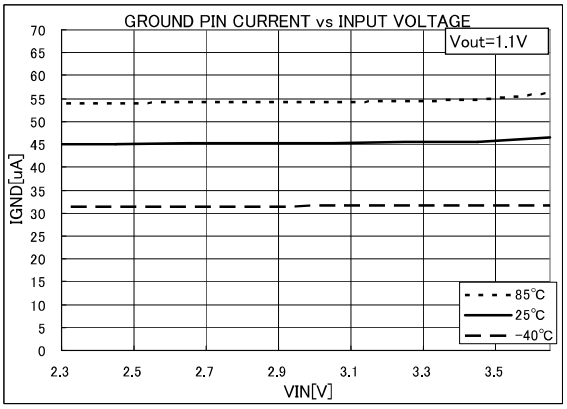


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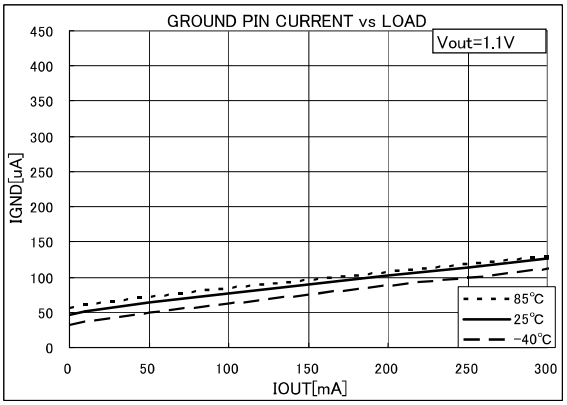


Figure 28.

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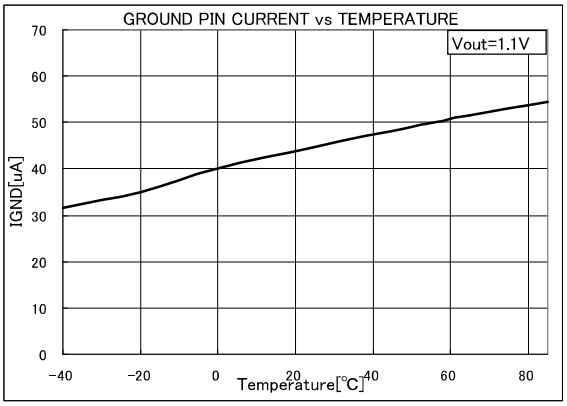


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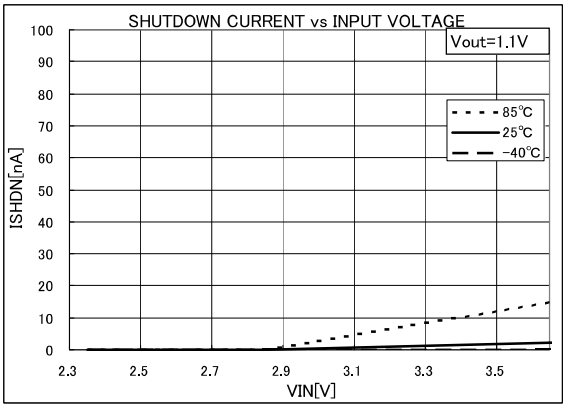


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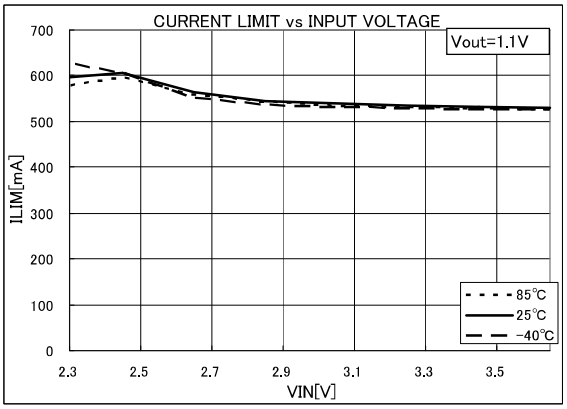


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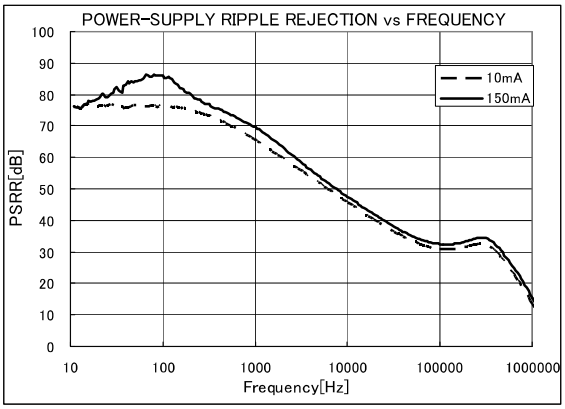


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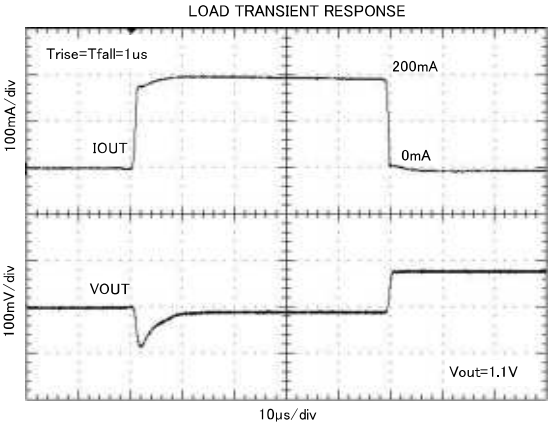


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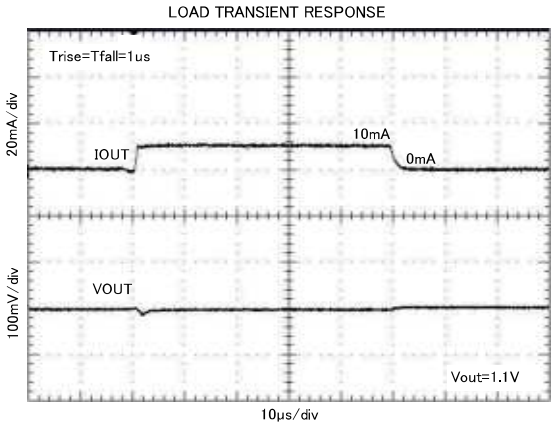


Figure 34.

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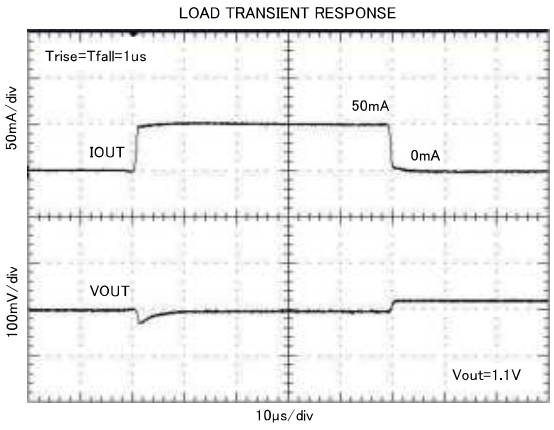


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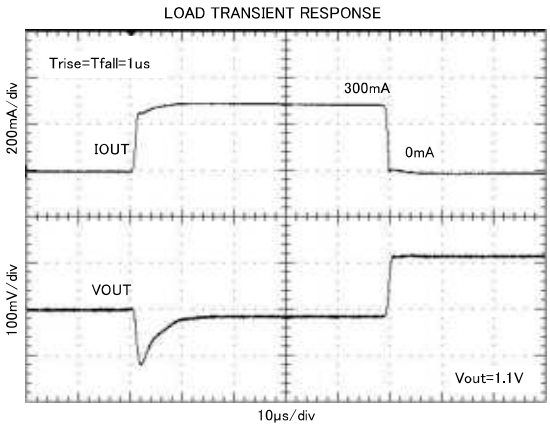


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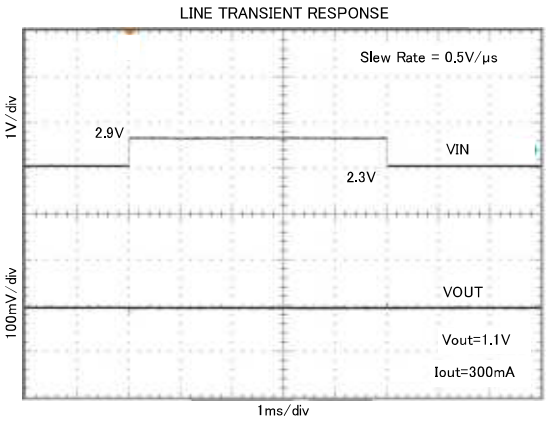


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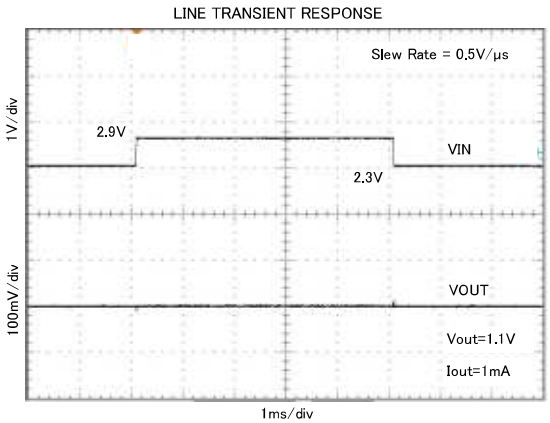


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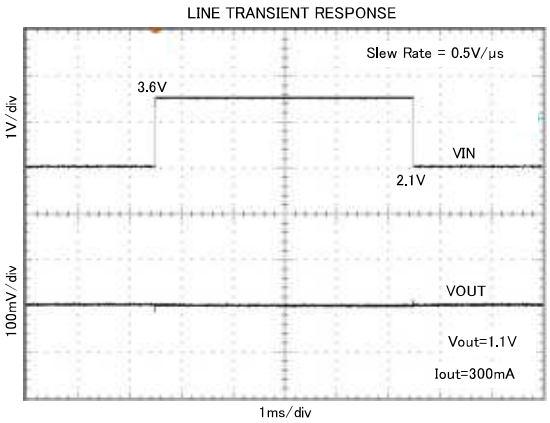


Figure 39.

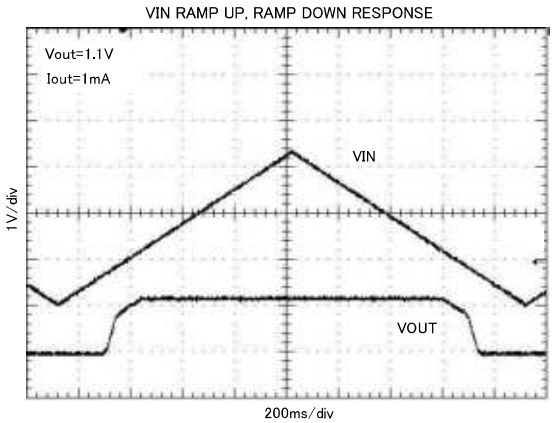


Figure 40.

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● **Reference data** **BU11UA3WNVX** (Ta=25ºC unless otherwise specified.)

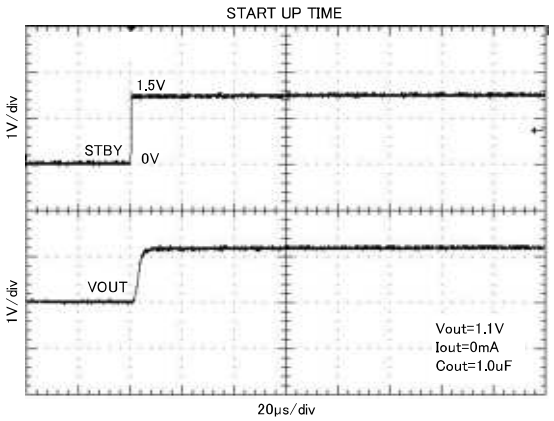


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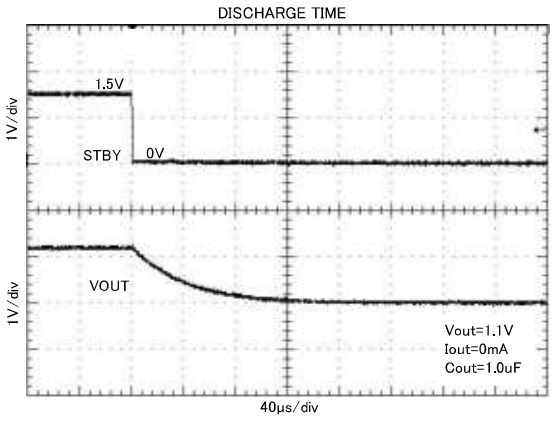


Figure 42.

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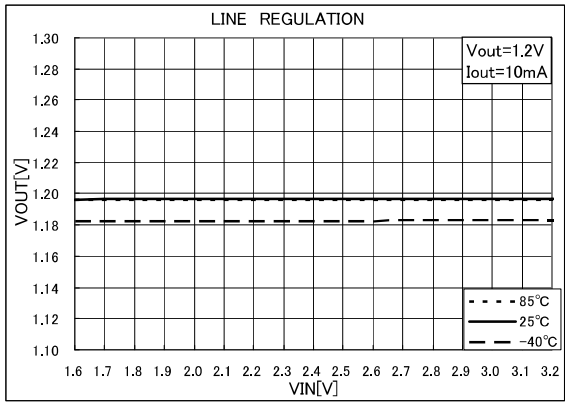


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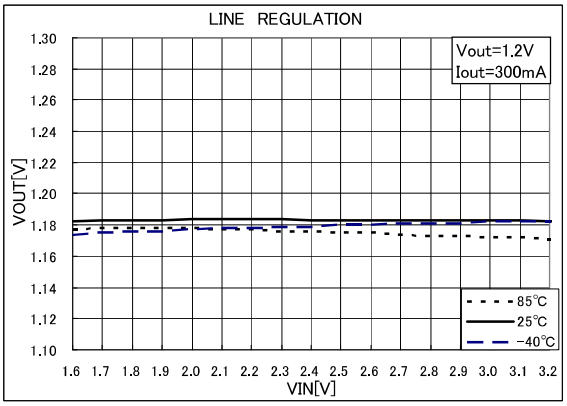


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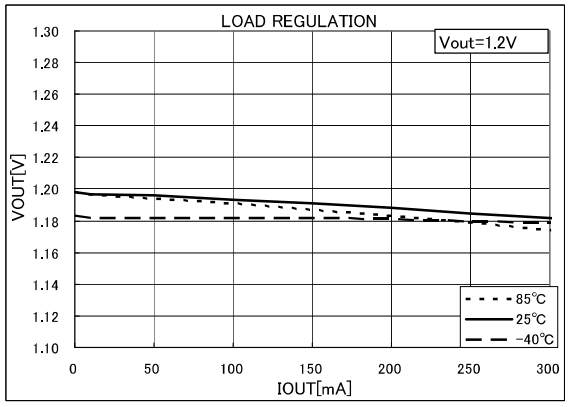


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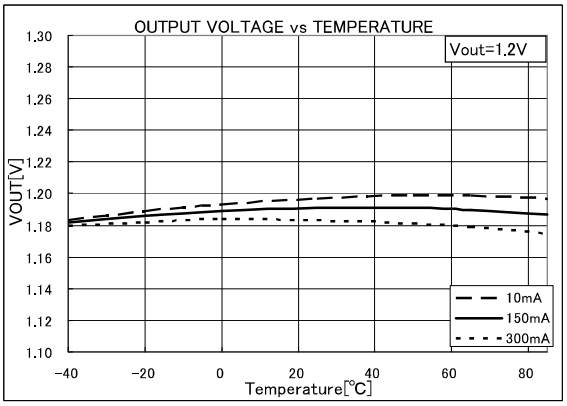


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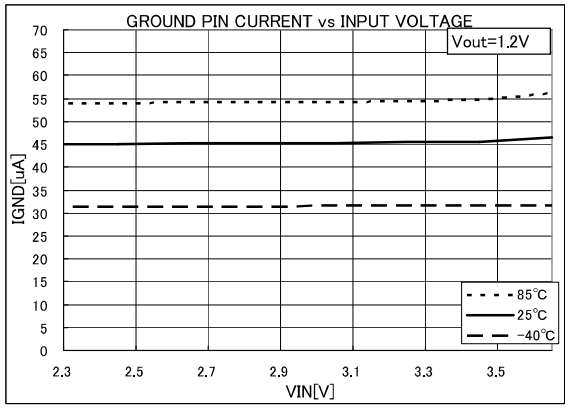


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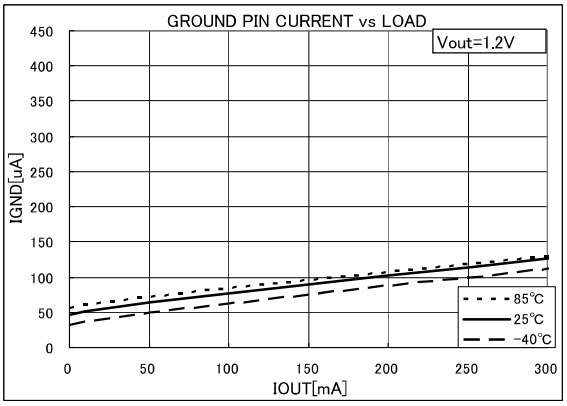


Figure 48.

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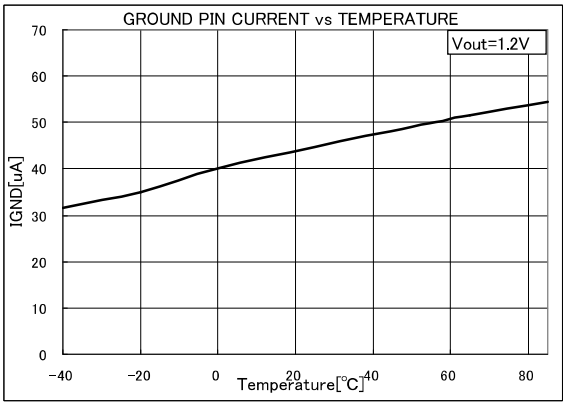


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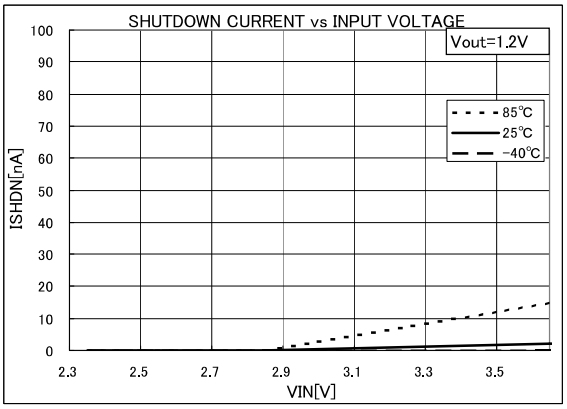


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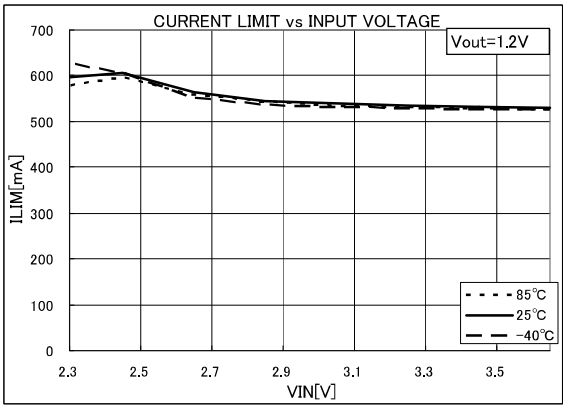


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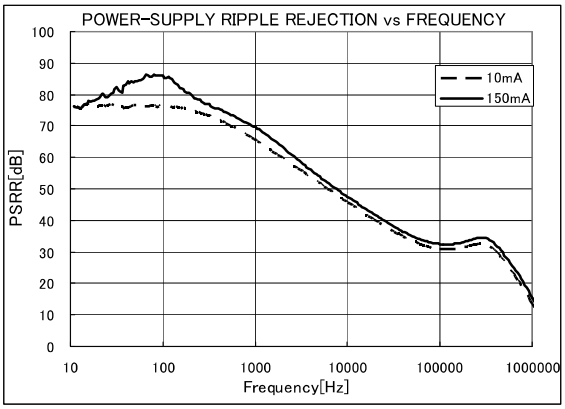


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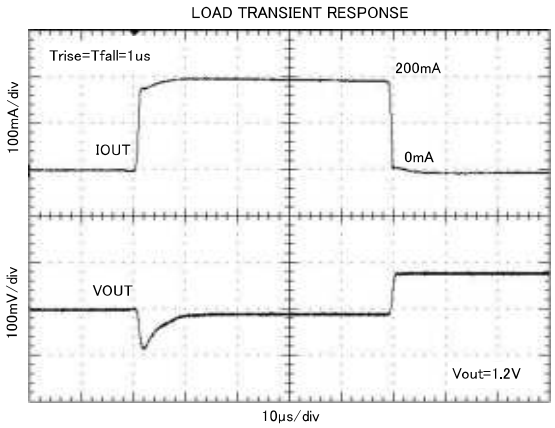


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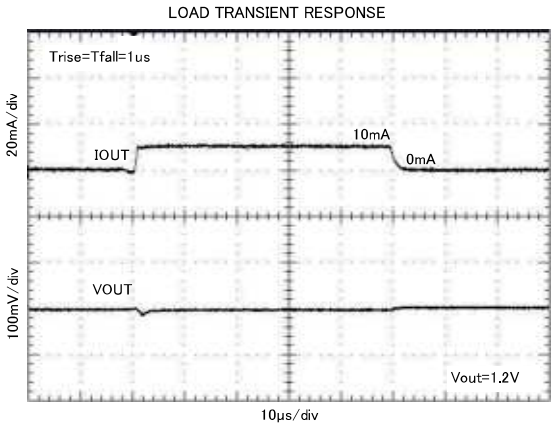


Figure 54.

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● **Reference data** **BU12UA3WNVX** (Ta=25ºC unless otherwise specified.)

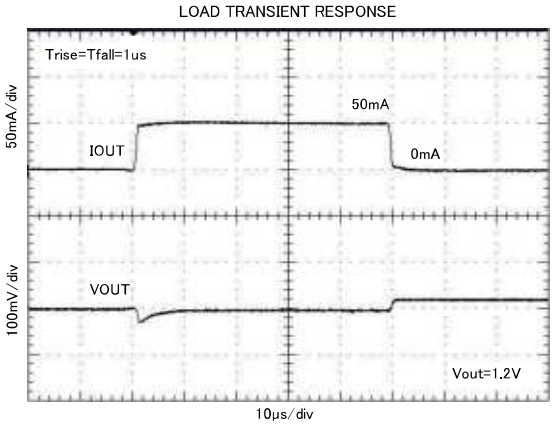


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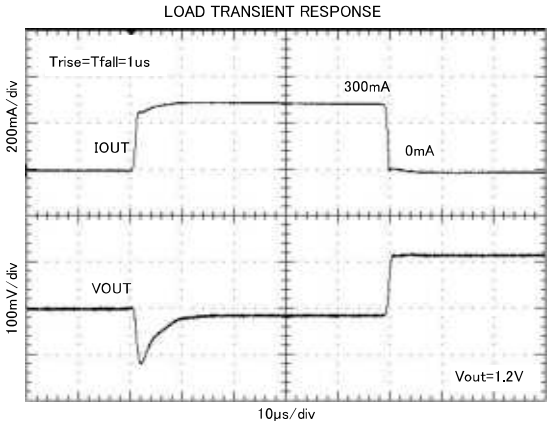


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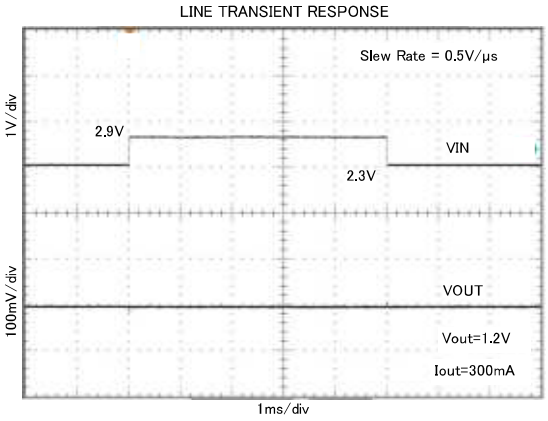


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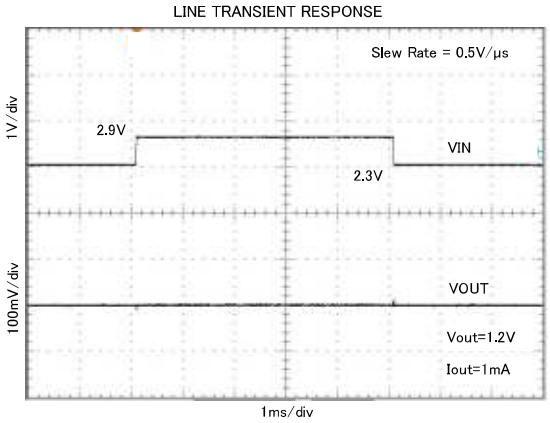


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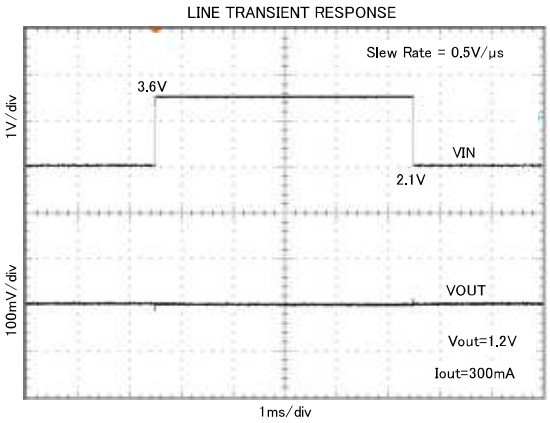


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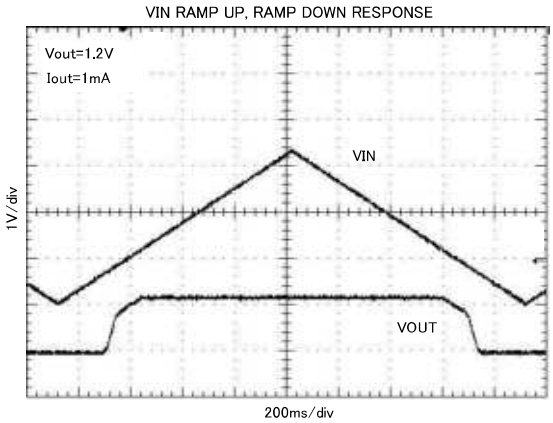


Figure 60.

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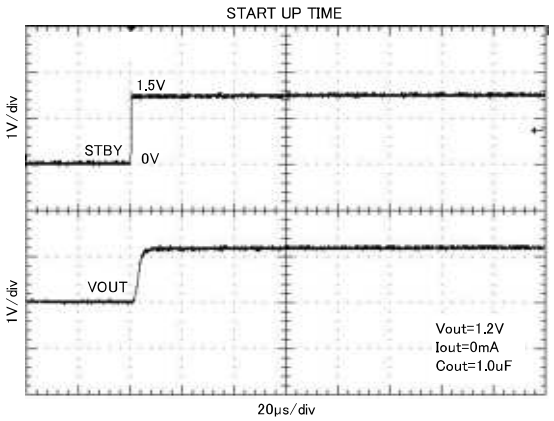


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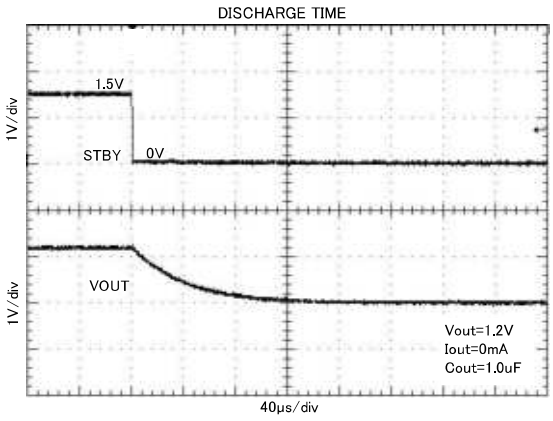


Figure 62.

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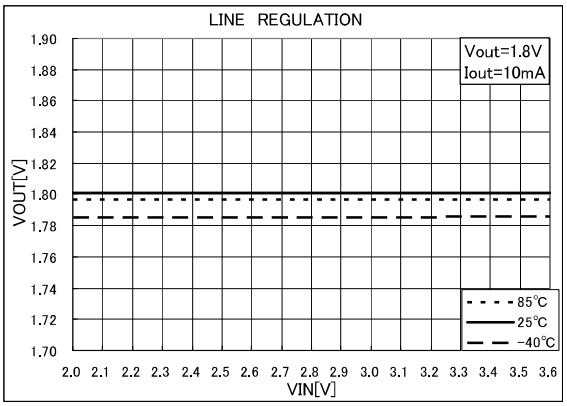


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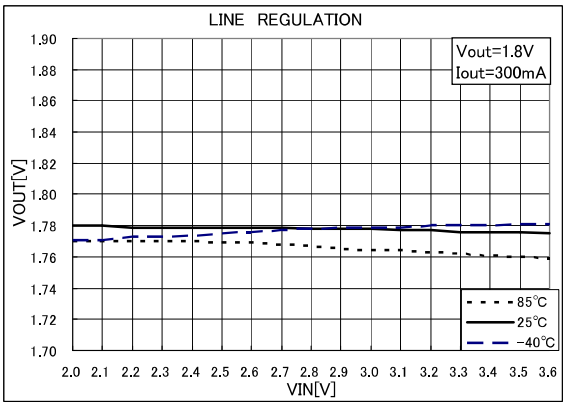


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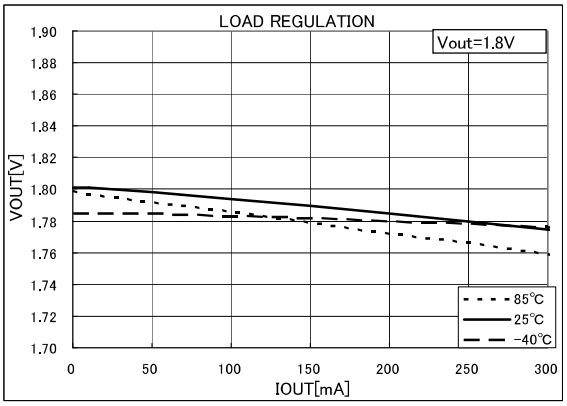


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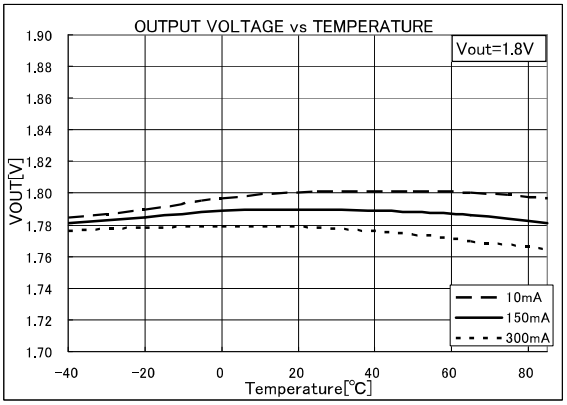


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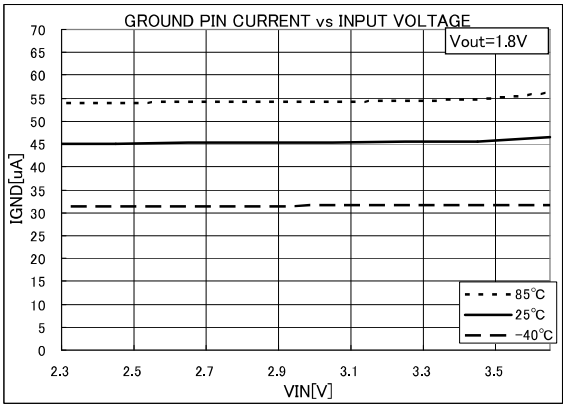


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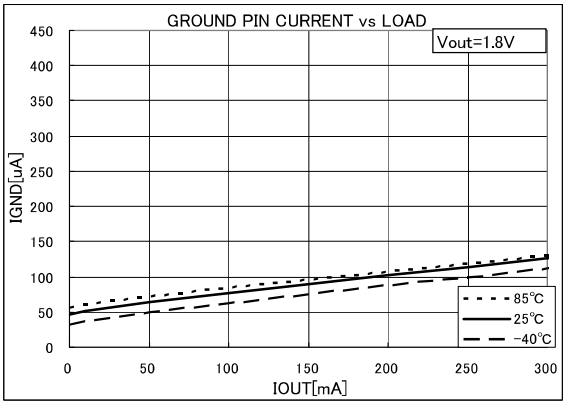


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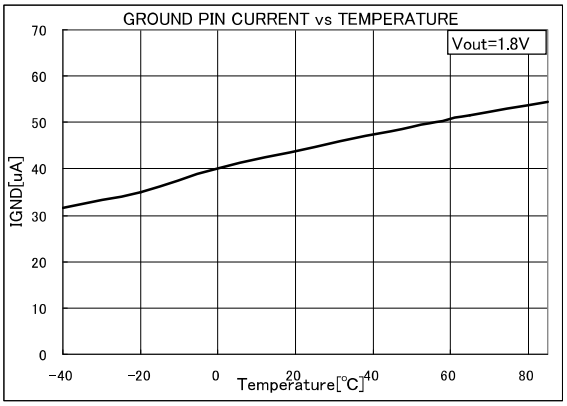


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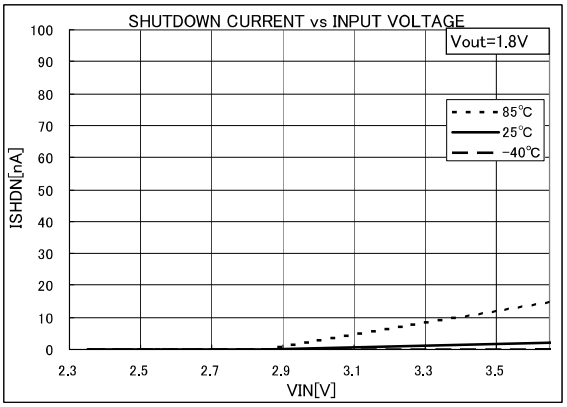


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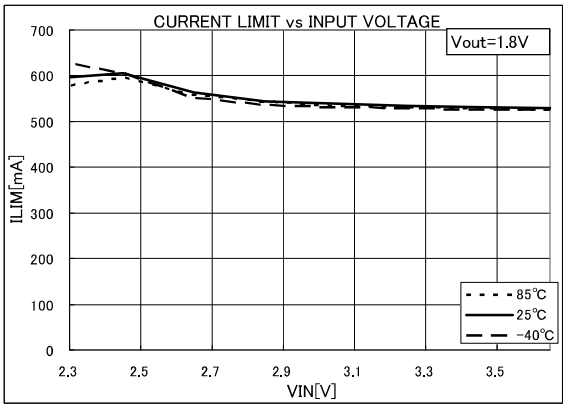


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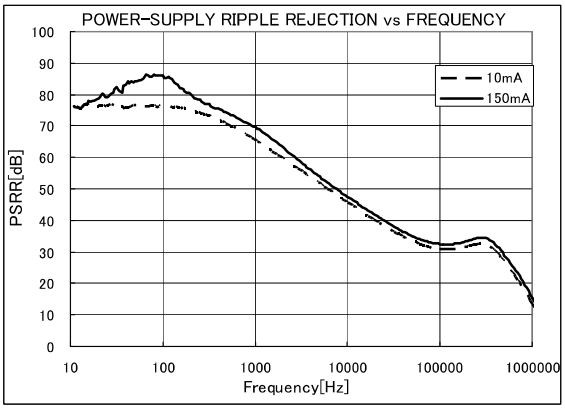


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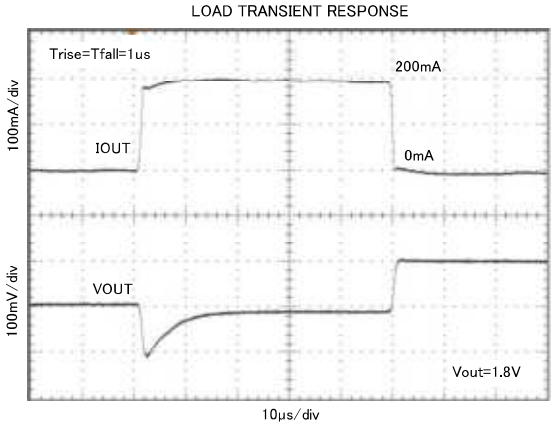


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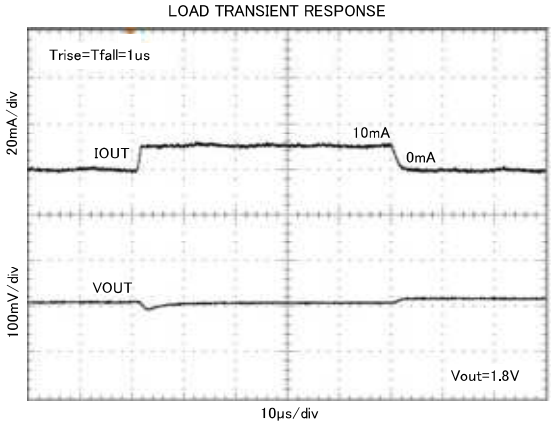


Figure 74.

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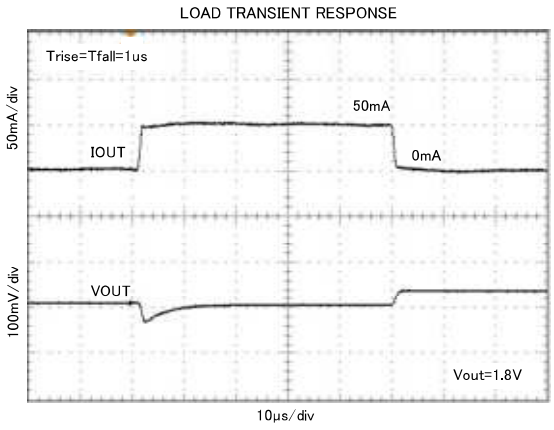


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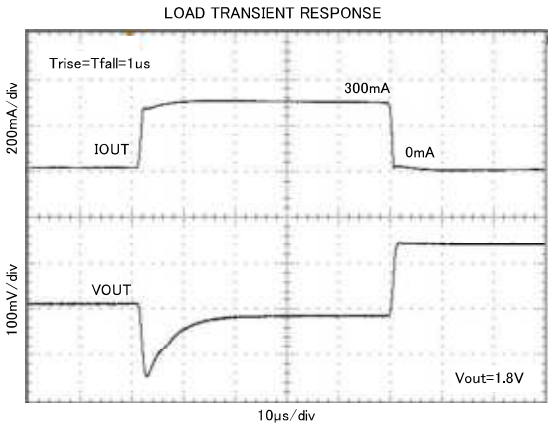


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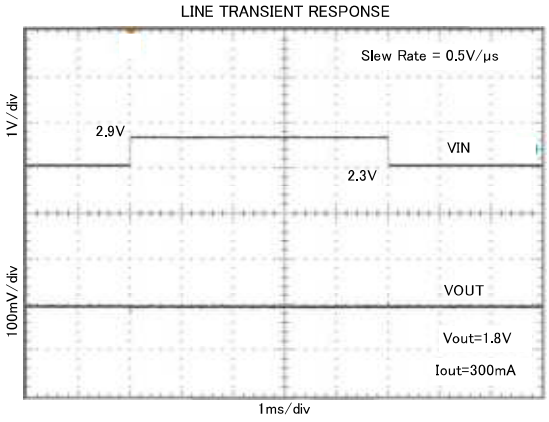


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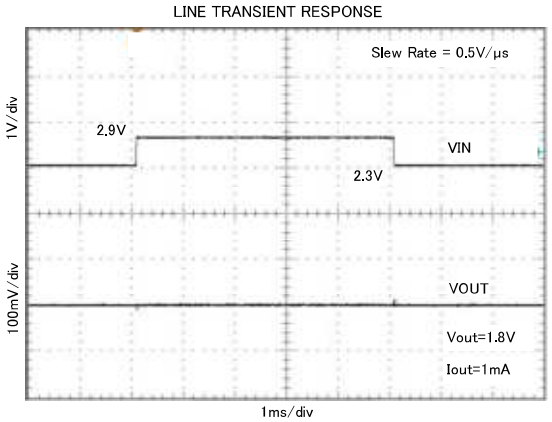


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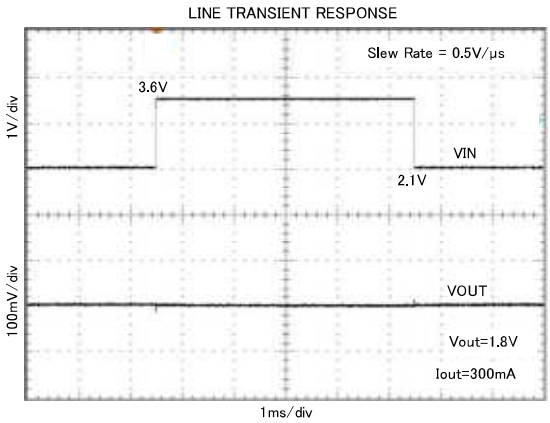


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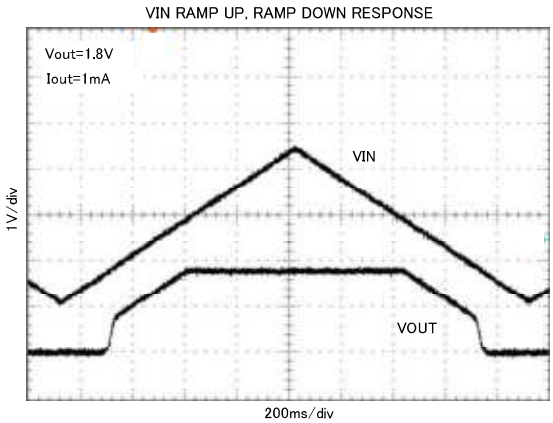


Figure 80.

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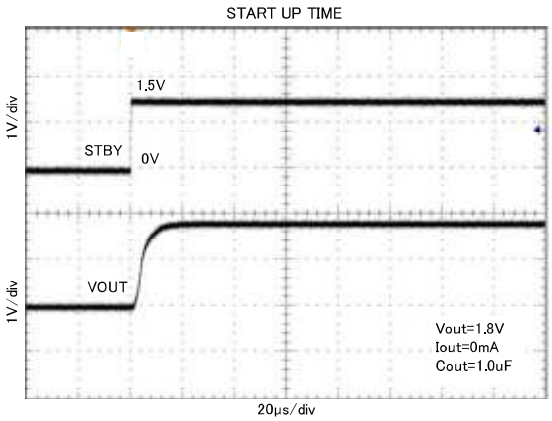


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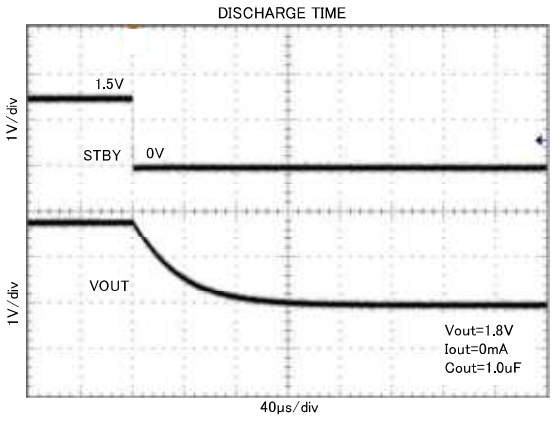


Figure 82.

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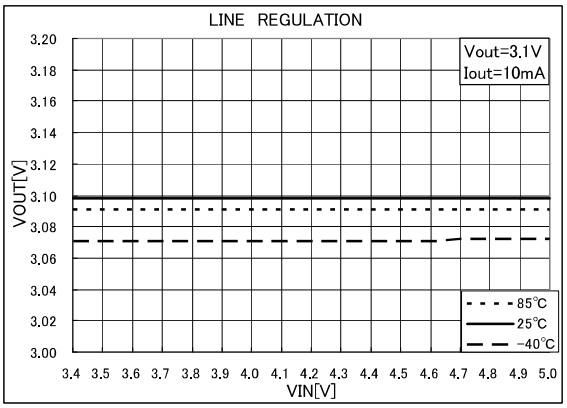


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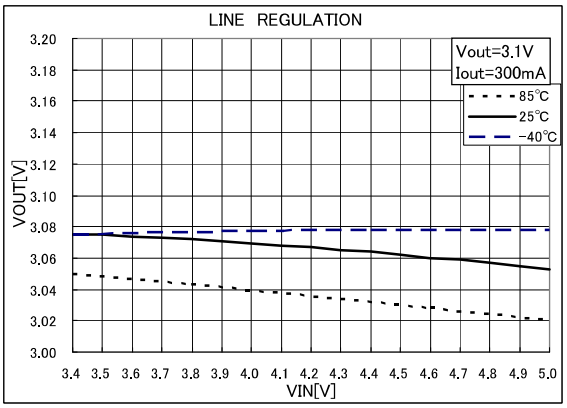


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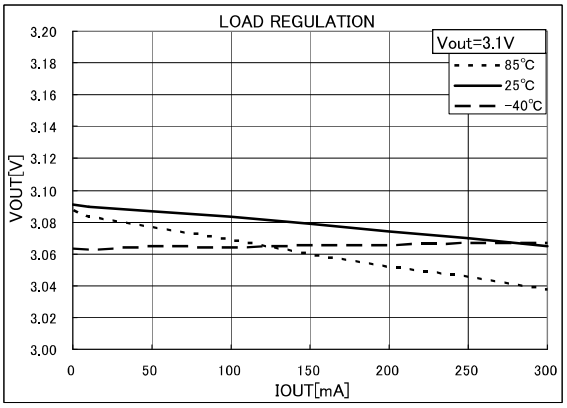


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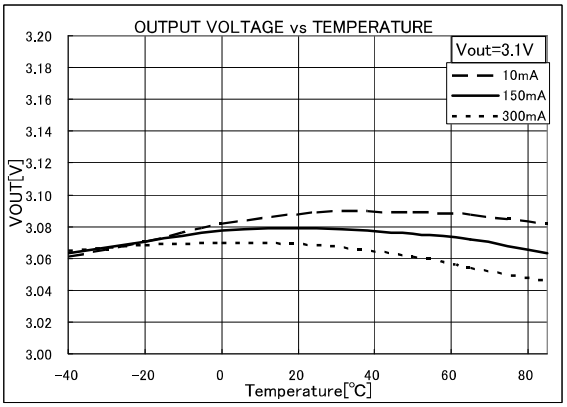


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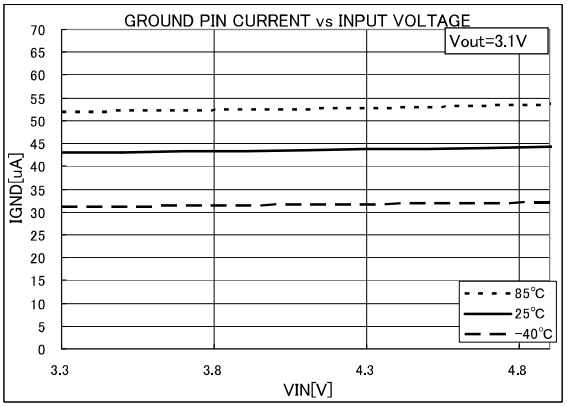


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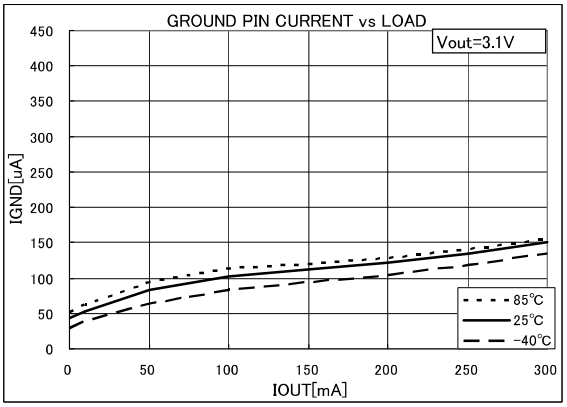


Figure 88.

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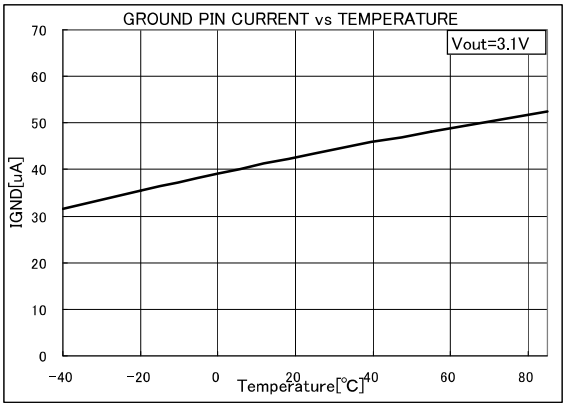


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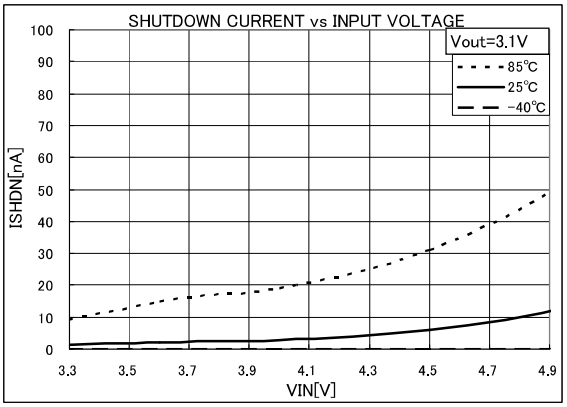


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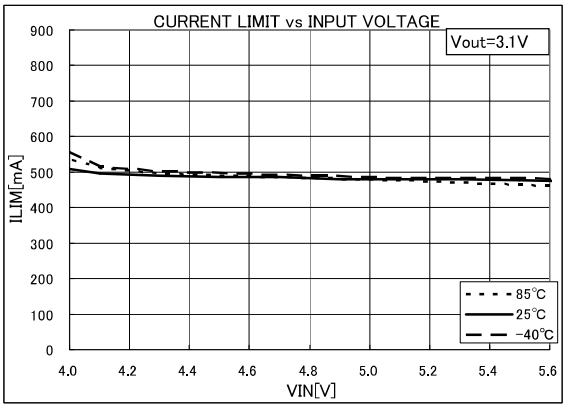


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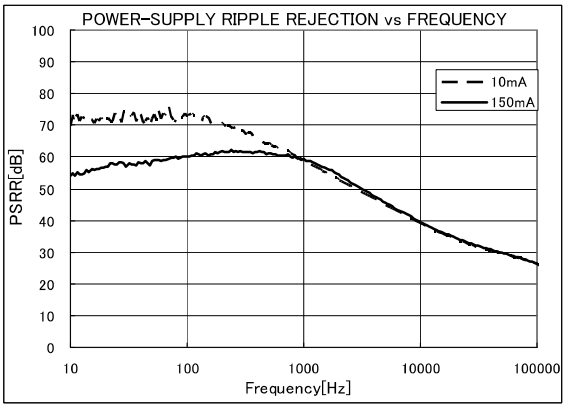


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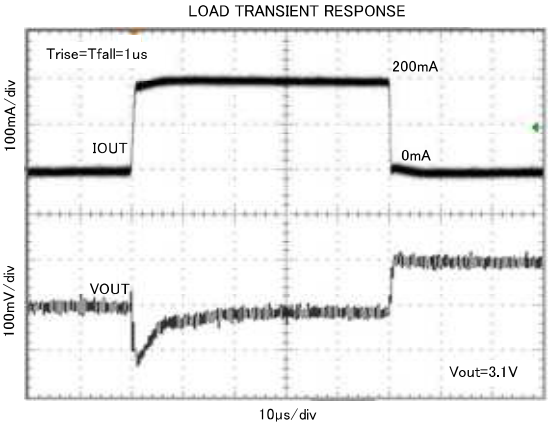


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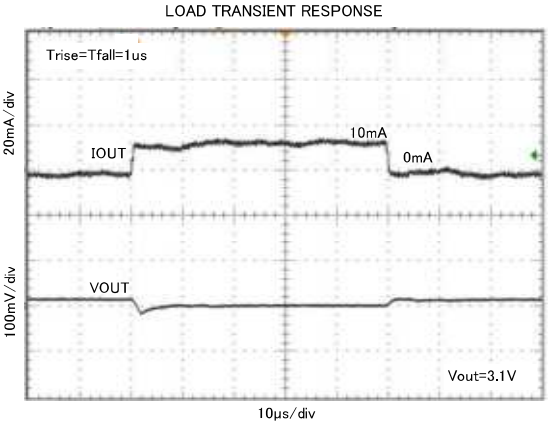


Figure 94.

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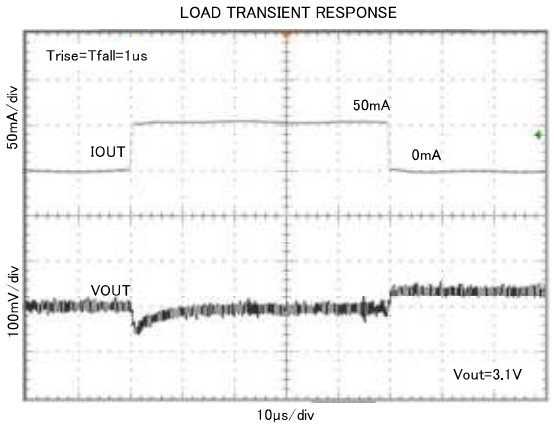


Figure 95.

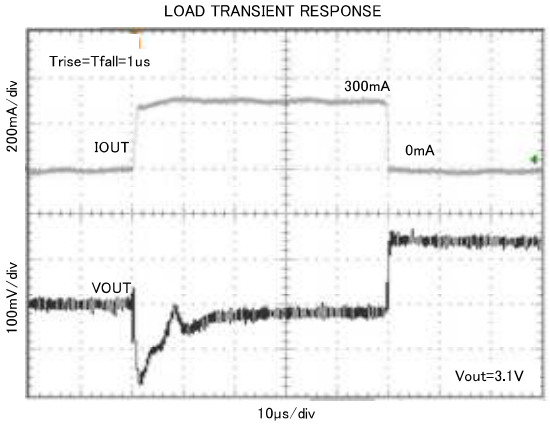


Figure 96.

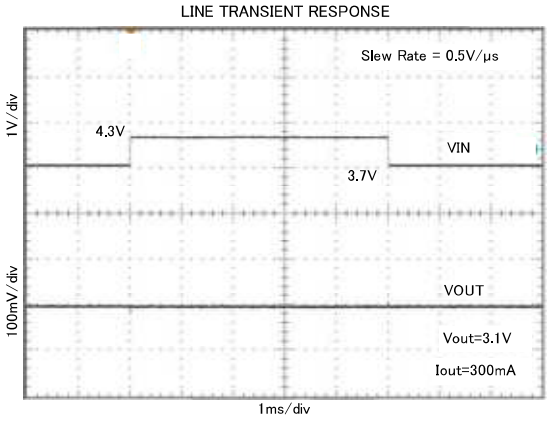


Figure 97.

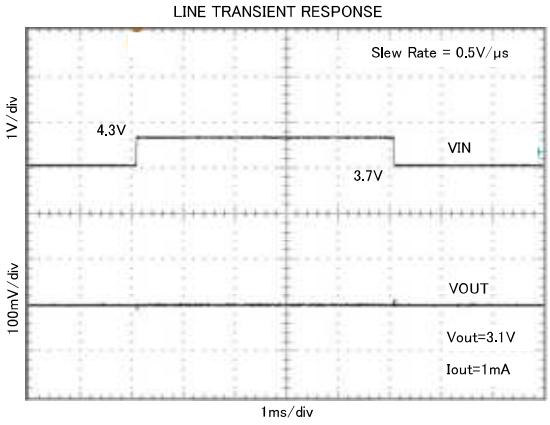


Figure 98.

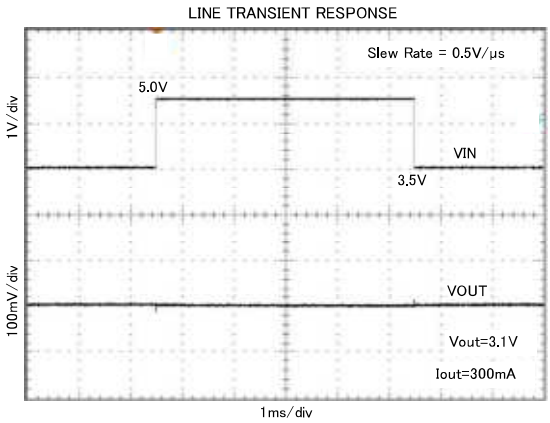


Figure 99.

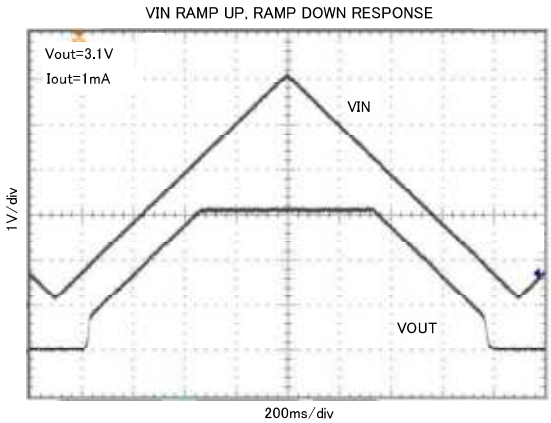


Figure 100.

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● **Reference data** **BU31UA3WNVX** (Ta=25ºC unless otherwise specified.)

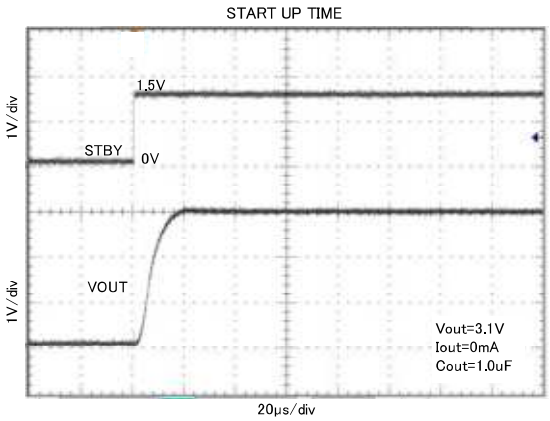


Figure 101.

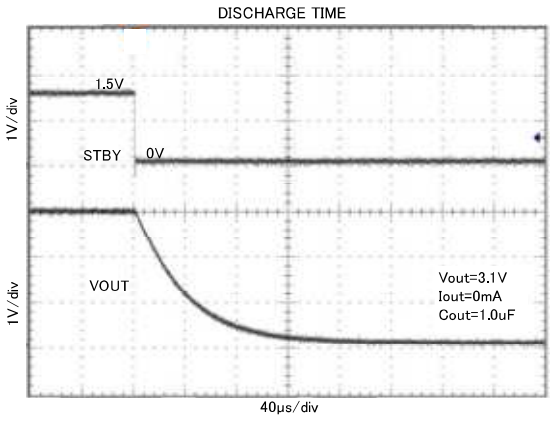


Figure 102.

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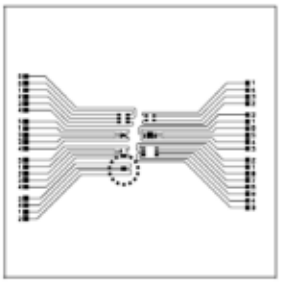
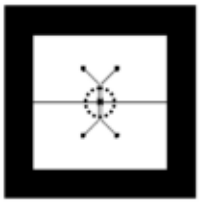
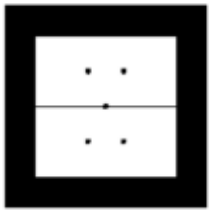
● **About power dissipation (Pd)**

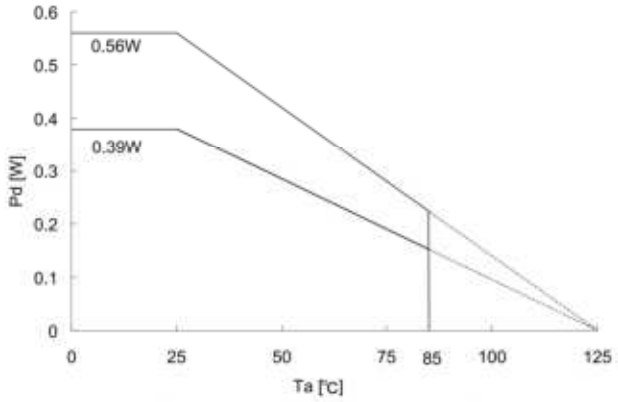
As for power dissipation, an approximate estimate of the heat reduction characteristics and internal power consumption of IC are shown, so please use these for reference. Since power dissipation changes substantially depending on the implementation conditions (board size, board thickness, metal wiring rate, number of layers and through holes, etc.), it is recommended to measure Pd on a set board. Exceeding the power dissipation of IC may lead to deterioration of the original IC performance, such as causing operation of the thermal shutdown circuit or reduction in current capability. Therefore, be sure to prepare sufficient margin within power dissipation for usage.

Calculation of the maximum internal power consumption of IC (PMAX)

PMAX=(VIN-VOUT)×IOUT(MAX.) (VIN: Input voltage VOUT: Output voltage IOUT(MAX): Maximum output current)

○ Measurement conditions

		Standard ROHM Board	Evaluation Board 1
Layout of Board for Measurement IC Implementation Position		 Top Layer (Top View)  Bottom Layer (Top View)	 Top Layer (Top View)  Bottom Layer (Top View)
Measurement State		With board implemented (Wind speed 0 m/s)	With board implemented (Wind speed 0 m/s)
Board Material		Glass epoxy resin (Double-side board)	Glass epoxy resin (Double-side board)
Board Size		70 mm x 70 mm x 1.6 mm	40 mm x 40 mm x 1.6 mm
Wiring Rate	Top layer	Metal (GND) wiring rate: Approx. 0%	Metal (GND) wiring rate: Approx. 50%
	Bottom layer	Metal (GND) wiring rate: Approx. 50%	Metal (GND) wiring rate: Approx. 50%
Through Hole		Diameter 0.5mm x 6 holes	Diameter 0.5mm x 25 holes
Power Dissipation		0.56W	0.39W
Thermal Resistance		θja=178.6°C/W	θja=256.4°C/W



* Please design the margin so that PMAX becomes is than Pd (PMAX<Pd) within the usage temperature range

Figure 103. SSON004X1010 Power dissipation heat reduction characteristics (Reference)

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●**Operation Notes**

1.) Absolute maximum ratings

Use of the IC in excess of absolute maximum ratings (such as the input voltage or operating temperature range) may result in damage to the IC. Assumptions should not be made regarding the state of the IC (e.g., short mode or open mode) when such damage is suffered. If operational values are expected to exceed the maximum ratings for the device, consider adding protective circuitry (such as fuses) to eliminate the risk of damaging the IC.

2.) GND potential

The potential of the GND pin must be the minimum potential in the system in all operating conditions.
Never connect a potential lower than GND to any pin, even if only transiently.

3.) Thermal design

Use a thermal design that allows for a sufficient margin for that package power dissipation rating (Pd) under actual operating conditions.

4.) Inter-pin shorts and mounting errors

Use caution when orienting and positioning the IC for mounting on printed circuit boards. Improper mounting or shorts between pins may result in damage to the IC.

5.) Common impedance

Wiring traces should be as short and wide as possible to minimize common impedance. Bypass capacitors should be use to keep ripple to a minimum.

6.) Voltage of STBY pin

To enable standby mode for all channels, set the STBY pin to 0.3 V or less, and for normal operation, to 1.2 V or more. Setting STBY to a voltage between 0.3 and 1.2 V may cause malfunction and should be avoided. Keep transition time between high and low (or vice versa) to a minimum.

Additionally, if STBY is shorted to VIN, the IC will switch to standby mode and disable the output discharge circuit, causing a temporary voltage to remain on the output pin. If the IC is switched on again while this voltage is present, overshoot may occur on the output. Therefore, in applications where these pins are shorted, the output should always be completely discharged before turning the IC on.

7.) Over-current protection circuit (OCP)

This IC features an integrated over-current and short-protection circuitry on the output to prevent destruction of the IC when the output is shorted. The OCP circuitry is designed only to protect the IC from irregular conditions (such as motor output shorts) and is not designed to be used as an active security device for the application. Therefore, applications should not be designed under the assumption that this circuitry will engage.

8.) Thermal shutdown circuit (TSD)

This IC also features a thermal shutdown circuit that is designed to turn the output off when the junction temperature of the IC exceeds about 150℃. This feature is intended to protect the IC only in the event of thermal overload and is not designed to guarantee operation or act as an active security device for the application. Therefore, applications should not be designed under the assumption that this circuitry will engage.

9.) Input/output capacitor

Capacitors must be connected between the input/output pins and GND for stable operation, and should be physically mounted as close to the IC pins as possible. The input capacitor helps to counteract increases in power supply impedance, and increases stability in applications with long or winding power supply traces. The output capacitance value is directly related to the overall stability and transient response of the regulator, ¿Unstable regionset to the largest possible value for the application to increase these characteristics. During design, keep in mind that in general, ceramic capacitors have a wide range of tolerances, temperature coefficients and DC bias characteristics, and that their capacitance values tend to decrease over time. Confirm these details before choosing appropriate capacitors for your application.(Please refer the technical note, regarding ceramic capacitor of recommendation)

10.) About the equivalent series resistance (ESR) of a ceramic capacitor

Capacitors generally have ESR (equivalent series resistance) and it operates stably in the ESR-IOUT area shown on the right. Since ceramic capacitors, tantalum capacitors, electrolytic capacitors, etc. generally have different ESR, please check the ESR of the capacitor to be used and use it within the stability area range shown in the right graph for evaluation of the actual application.

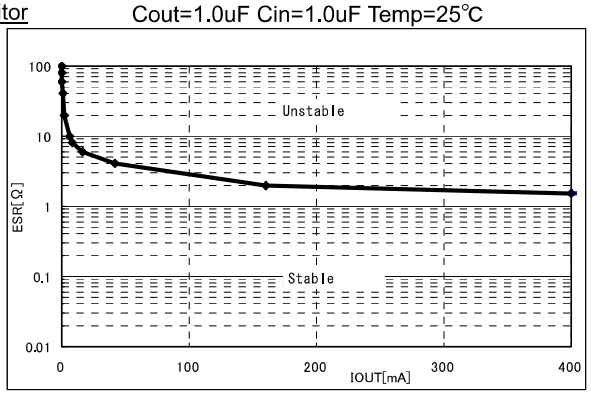


Figure 104. Stable region (example)

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●Revision History

Date	Revision	Changes
31.Jan.2013	001	New Release.
20.Feb.2013	002	Package size is changed.
21.Feb.2013	003	Adding a revision history Adding a lineup. The condition of drop voltage is changed.
19.Apr.2013	004	Adding lineup.
28.Jun.2013	005	Adding reference data.
06.Sep.2013	006	Adding Pin Descriptions. Adding BOTTOM VIEW.
05.Feb.2014	007	Adding reference data
10.Oct.2015	008	Lineup is changed.

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(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASSⅡb	CLASSⅢ
CLASSⅣ		CLASSⅢ	

2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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   [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure

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   [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
   [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
   [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl_2, H_2S, NH_3, SO_2, and NO_2
   [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
   [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
   [f] Sealing or coating our Products with resin or other coating materials
   [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
   [h] Use of the Products in places subject to dew condensation

4. The Products are not subject to radiation-proof design.

5. Please verify and confirm characteristics of the final or mounted products in using the Products.

6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.

7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.

8. Confirm that operation temperature is within the specified range described in the product specification.

9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.

2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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Precautions Regarding Application Examples and External Circuits

1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.

2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of Ionizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
   - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
   - [b] the temperature or humidity exceeds those recommended by ROHM
   - [c] the Products are exposed to direct sunshine or condensation
   - [d] the Products are exposed to high Electrostatic

2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.

3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.

4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

QR code printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

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Since concerned goods might be fallen under listed items of export control prescribed by Foreign exchange and Foreign trade act, please consult with ROHM in case of export.

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